IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: T. HATTORI, et al.

Serial No.: 10/576,494

Filed: APRIL 20, 2006

For: POSITIVE PHOTOSENSITIVE RESIN COMPOSITION, METHOD

FOR FORMING PATTERN, AND ELECTRONIC PART

Group AU: 1752

Examiner: John S. Y. Chu

Confirm. No: 3727

AMENDMENT

Mail Stop: AMEND – NO FEE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

September 27, 2007

Sir:

In response to the Office Action dated June 28, 2007, please amend the aboveidentified application as listed below and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.